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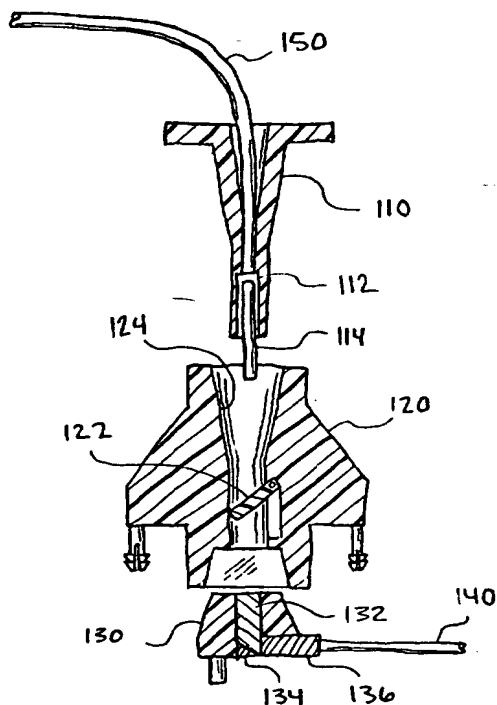
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(54) Title: FIBER OPTIC CIRCUIT BOARD CONNECTOR



(57) Abstract: An optical connector for use in multilayer electro-optic circuit boards. An electro-optical back plane circuit board uses both electrical and optical connectors to carry signals in both electrical and light form. The optical connector employs redundant alignment features to provide for reliable connectivity between plug in boards and the electro-optic back plane. A process of forming the back plane and other multilevel circuit boards so as to embed optical connectors is disclosed.

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EPO-Internal, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

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X	US 4 465 333 A (CASERTA ANTHONY L ET AL) 14 August 1984 (1984-08-14) the whole document ---	1-5
A	EP 0 677 757 A (NOZICK JACQUES) 18 October 1995 (1995-10-18) column 2, line 32 -column 3, line 13; figure 1 ---	1-5
A	US 4 753 510 A (SEZERMAN OMUR M) 28 June 1988 (1988-06-28) column 9, line 48 - line 66; figure 6A ---	1-5
A	US 6 004 043 A (ABENDSCHEIN FREDERIC HENRY ET AL) 21 December 1999 (1999-12-21) column 2, line 24 - line 60; figures 1-5. -----	1-5

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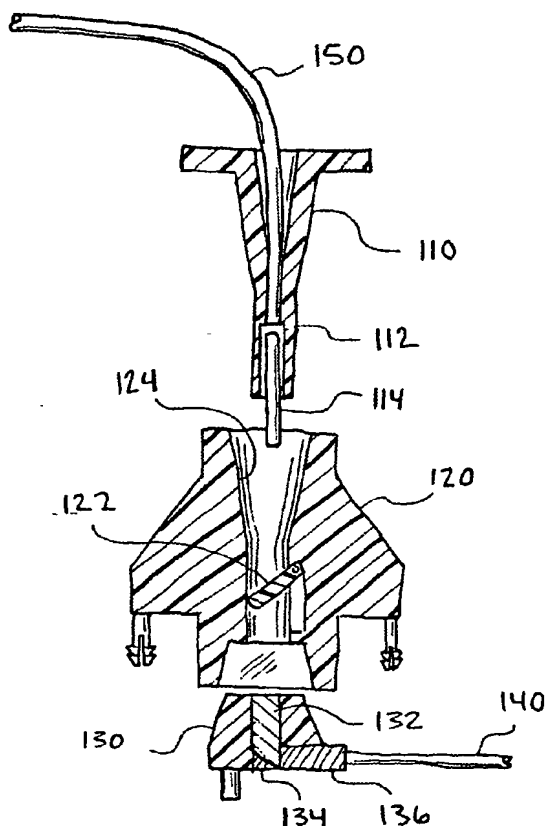
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FIBER OPTIC CIRCUIT BOARD CONNECTOR

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] This application claims priority under 35 U.S.C. § 119(e) from provisional application no. 60/244,389, filed October 31, 2000. The 60/244,389 provisional application is incorporated by reference herein, in its entirety, for all purposes.

INTRODUCTION

[0002] The present invention relates generally to the field of optical connectors for circuit boards. More particularly, the present invention relates to electro-optical back plane circuit boards that have both electrical and optical connectors.

BACKGROUND OF THE INVENTION

[0003] Electronics devices are becoming increasingly integrated with optical systems. This has given rise to the need to integrate electronics and optics together into printed circuit board systems. Currently, this integration is somewhat awkward.

[0004] Although printed circuit wiring is a fairly mature technology, the mixing of printed circuit wiring with optical conduction paths is still at an awkward stage of development. Additionally, the connectors for interfacing optical conduction paths on circuit boards with fibers off-board is still a challenge. Specifically, aligning the off-board optical fibers with the connectors on the board remains a reliability problem.

[0005] Thus, what is needed is a printed circuit board configuration that reliably integrates electrical conduction with optic conduction, including stable optical connectors.

SUMMARY OF THE INVENTION

[0006] One aspect of the present invention is an optical connector for use in a multilayer circuit board.

[0007] Another aspect of the present invention is a method for forming an electro-optical multilayer circuit board having embedded optical connectors.

[0008] It is also an aspect of the present invention to embed an optical connector in a multilayer circuit board using a guide plate and pins to align the optical connector with the various layers of the circuit board.

[0009] An additional aspect of the present invention is an electro-optical back plane having both electrical connectors and optical connectors.

[0010] One embodiment of the present invention is an optical connector for use with an electro-optical board. The optical connector includes a right angle interface body that has one or more first optical paths and one or more second optical paths. Each of the first optical paths corresponding to a respective second optical path, and the first optical paths are disposed in a first plane and the one or more second optical paths are disposed in a second plane. The first and second planes being substantially at right angles with respect to one another. The optical connector also includes a female self-alignment body that has a tapered channel substantially aligned with the first plane. The optical connector further includes a tapered male self-alignment body sized to fit closely into the tapered channel of the female self-alignment body, and having one or more third optical paths adapted to align with the first optical paths when the tapered male self-alignment body is engaged with the female self-alignment body. The third optical paths are adapted for connection to one or more optical fibers disposed outside the electro-optical board. The second optical paths are adapted for connection to optical fibers embedded in the electro-optical board.

[0011] Another embodiment of the present invention is a method of integrating into an optical-electrical board an optical connector that includes a right angle interface body, a female self-alignment body having a tapered channel, and an anchor body. The method includes the steps of connecting the right angle interface body to a set of one or more optical fibers, and embedding the right angle interface body and the one or more optical fibers inside the optical-electrical board. The method also includes the steps of forming a hole in the optical-electrical board to expose an upper surface of the embedded right angle interface body, securely fastening the anchor body about the hole, and inserting the female self-alignment body through the anchor body and the hole so as to bring the tapered channel into registration with the embedded right angle interface body.

[0012] Yet another embodiment of the present invention is an electro-optical back plane. The electro-optical back plane includes a fiber management system formed of plural

optical fibers, an electrical bus circuit, and a board, wherein the fiber management system and the electrical bus circuit are embedded inside the board. The electro-optical back plane further includes plural optical connectors disposed on the board, each of the optical connectors being coupled to one or more of the plural optical fibers of the fiber management system. Additionally, the electro-optical back plane includes plural electrical connectors disposed on the board, each of the electrical connectors being electrically connected to the electrical bus circuit. Each of the optical connectors includes a right angle interface body embedded into the board for connection to one or more fibers of the fiber management system, an anchor body securely fastened to the surface of the board, and a female self-alignment body having a tapered channel. The female self-alignment body is held by the anchor body so that the tapered channel is in registration with an upper surface of the right angle interface body.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0013] Additional objects and advantages of the present invention will be apparent in the following detailed description read in conjunction with the accompanying drawing figures.
- [0014] Fig. 1 illustrates a sectional exploded view of parts of an optical connector according to an embodiment of the present invention.
- [0015] Fig. 2 illustrates a perspective view of a right angle interface body according to an embodiment of the present invention.
- [0016] Fig. 3 illustrates a sectional view of the right angle interface body of Fig. 2.
- [0017] Fig. 4 illustrates another sectional view of the right angle interface body of Fig. 2 (orthogonal to the sectional view of Fig. 3).
- [0018] Fig. 5 illustrates an initial pre-assembly schematic view of various lamination layers for composing a multilayer printed circuit board according to an embodiment of the present invention.
- [0019] Fig. 6 illustrates a post-lamination cross sectional view of a multilayer circuit board according to a process embodiment of the present invention.
- [0020] Fig. 7 illustrates a cross sectional view of a multilayer circuit board illustrating a machining step of a process embodiment of the present invention.

[0021] Fig. 8 illustrates a cross sectional view of a multilayer circuit board illustrating a connector assembly step of a process embodiment of the present invention.

[0022] Fig. 9 illustrates a cross sectional view of a multilayer circuit board illustrating another connector assembly step of a process embodiment of the present invention.

[0023] Fig. 10 illustrates a cross sectional detail view (per section line X in Fig. 9) showing the ratcheted interface between an anchor body and a female self-alignment body that form the female connector portion according to an embodiment of the present invention.

[0024] Fig. 11 illustrates a partial section view of a fully assembled optical connector according to an embodiment of the present invention.

[0025] Fig. 12 illustrates a schematic view of an electro-optical back plane according to an embodiment of the present invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0026] Referring to Fig. 1, and exploded sectional view of a connector according to an embodiment of the present invention is illustrated. A male connector portion 110 is insertable into a female connector portion 120. The male and female connector portions 110, 120 are tapered to fit together so as to provide a self-aligning function. A micro machined optical conductor assembly 112 in the male connector portion 110 is cause to be brought into precise alignment with another micro machined optical conductor assembly 132 disposed in a right angle interface body 130. The female connector portion 120 guides the male connector portion 110 into precise registration with the right angle interface body 130.

[0027] The housing parts of the optical connector are preferably formed of a high Tg material. Polyetherimide resins, and in particular ULTEM® resin (a product of GE), have been found to be a suitable as housing material to embody the invention.

[0028] The right angle interface body 130 is to be embedded inside a multi-layer circuit board. The female connector portion 120 mounts on a surface of the multi-layer circuit board, with a lower portion thereof extending down into the circuit board to engage the right angle interface body 130. The micro machined optical conductor assembly 132 is

disposed above an integrated mirror **134** that provided a 90° transition for light traveling through the connector. This reflected light also travels through an additional micro machined conductor assembly **136** that provides coupling to a plurality of optical fibers **140**, which are embedded inside the multilayer circuit board.

[0029] An optional feature of the optical connector **100** according to this embodiment is a spring-loaded door **122** inside the tapered passageway **124** of the female connector portion **120**. The spring-loaded door **122** provides two functions. First, it prevents debris from falling down inside the connector and contaminating the optical interface surface **131** on the top of the right angle interface body **130**. Secondly, the spring-loaded door **122** prevents light from being emitted through the tapered passageway **124** of the female connector portion **120** when no male connector portion **130** is inserted therein.

[0030] The female connector portion **120** is securely held to the surface of the multilayer circuit board via locking connectors **124** that are inserted into holes formed through the multilayer circuit board.

[0031] Off-board optical fibers **150** are connected into the male connector portion **110** so as to be in optical communication with the micro machined optical conductor assembly **112**. In addition to the self-aligning feature provided by the matched tapering shape of the male and female connector portions **110**, **120**, precision of alignment of the optical connector is enhanced by alignment pins **114** extending from the male connector portion that interdigitate with precisely machined alignment holes (not shown in this view) formed in the top side of the right angle interface body **130**.

[0032] Referring to **Fig. 2**, a perspective view of the right angle interface body **130** is illustrated. The precision alignment holes **138** are disposed on either end of the optical conductor assembly **132**. Plural optical conductors **137** (preferably glass fibers) embedded in a silicon body **139** to form the optical conductor assembly **132**. The optical conductor assembly is principally formed of silicon. MT type optical connector devices have been found to be suitable for embodying these assemblies.

[0033] Referring to **Fig. 3**, a sectional view of the right angle interface body **130** of **Fig. 2** is illustrated. Anchor members **135** extend downward from the bottom side of the right

angle interface body **130** to provide enhanced mechanical stability inside the multilayer circuit board.

[0034] Referring to **Fig. 4**, another sectional view of the right angle interface body **130** of **Fig. 2** is illustrated. Extending upwardly from the integrated mirror **134** through the micro machined optical conductor assembly **132** are plural glass fibers **137**.

[0035] Referring to **Fig. 5**, an initial pre-assembly schematic view is illustrated, showing the relative position of various lamination layers for composing the multi-layer printed circuit board. One layer is an electrical inner layer **502** according to known prior art practices. A registration plate **504** is provided to keep the board structure flat and having alignment holes to align and fix the optical connector during bonding. A prepreg layer **506** for bonding and embedding optical management structures is provided above the laminate layer **504**. About the right angle interface body **530**, a laminate layer **508** is provided with the perimeter of the fiber management system **540** being routed out to compensate for thickness differences. An adhesive copper tape **512** is layered onto the top surface of the right angle interface body **530** to protect the glass fibers, alignment holes, and other surrounding structures from later processing steps. The copper tape **512** is adhered to the top surface of the right angle interface body **530** by an adhesive. Preferably, the adhesive can withstand a temperature of at least 210°C and will not leave behind excessive residue when the copper tape **512** is later removed. Above the additional lamination layers **514**, an outer copper foil **510** is layered on as a top layer. The outer copper foil **510** is preferably about 18 micrometers in thickness.

[0036] The circuit board layers may be formed with any suitable materials that are known in the art. Standard circuit board materials are available from a number of manufacturers including Isola of the U.K., Nelco Products, Inc. of Fullerton, California, and Polyclad Laminates of Franklin, New Hampshire.

[0037] Referring to **Fig. 6**, a cross sectional view of the multilayer circuit board **600** is illustrated, post-lamination. The right angle interface body **530** is shown coupled to a fiber management system **540**, with both being embedded inside a multi-layer printed circuit board **600**. The right angle interface body **530**, a basic alignment component of the entire optical connector, is aligned to the circuit board **600** via a registration plate **504**. The registration plate **504** aligns and fixes the entire optical connector to the electrical

pattern of the printed circuit board 600 by fixing the anchor members 539 into the registration plate 504. The registration plate 504 is aligned to the other layers of the multi-layer printed circuit board 600 by using a traditional Lenkheit system.

[0038] The interlocking of the right angle interface body 530 with the registration plate 504 via the anchor members 539 aligns the optical connector both in the x-y plane of the board, as well as along the z axis.

[0039] It is noted that the right angle interface body 530 has angled sidewalls 531. These angled sidewalls 531 serve a dual purpose. One reason for having the angles sidewalls 531 is to facilitate cleaning around the interface body 530 with a laser that is used to ablate away the board layers above the interface body 530. The second useful purpose for the angled sidewalls is to provide for good alignment with the female connector portion.

[0040] Referring to Fig. 7, the multilayer printed circuit board 600 is shown after machining steps have been conducted on the board. Holes 602 have been drilled through the board 600 for connecting the female connector portion 920 to the surface of the board. A hole 604 has been machined into the upper surface of the board 600 and so is to expose the right angle interface body 530. The outer copper foil layer 510 has also been etched to provide conductive runs. At this time the copper tape 512 on the top of the right angle interface body 530 may be peeled off and the top surface of the right angle interface body cleaned 530. The protective copper tape 512 is left on the top surface of the right angle interface body 530 until the board 600 has been electrically tested and finally inspected.

[0041] Referring to Fig. 8, the first step of assembling the female connector portion is illustrated. An anchor body 822 is securely engaged to the surface of the board 600 by inserting its anchors 824 into the holes 602 drilled in the board 600.

[0042] Referring to Fig. 9, a second step of assembling the female connector portion is illustrated. A female self-alignment body 924 is forced downward through the anchor body 822 and into the machined out hole 604 in the board 600 until it aligns with the imbedded right angle alignment body 530.

[0043] Referring to Fig. 10, a detail view of the interface between the anchor body 822 and the female self-alignment body 924 is illustrated. The anchor body 822 engages the female self-alignment body 924 via a one way ratchet 926.

[0044] Referring to **Fig. 11**, the fully assembled optical connector **1100** is illustrated in a partial section view. A male self-alignment body **910** is inserted down into the female self-alignment body **920** (formed by the combination of the anchor body **822** and the female self-alignment body **924**) to guide the male connected portion into precise registration with the top surface of the right angle alignment body **530**. To insure precision of engagement between the optical paths of the male connector portion **910** with the optical paths of the right angle alignment body **530**, the alignment pins **914** of the male connector portion **910** are engaged with the precision machined holes **538** of the right angle alignment body **530**.

[0045] Referring to **Fig. 12**, an electro-optical back plane **1200** according to an embodiment of the present invention is illustrated. The back plane **1200** has an optical carrier **1210** (preferably a fiber management system) embedded with a number of optical connectors **1220** according to embodiments of the present invention. For interfacing printed circuit boards **1230** to the electro-optical back plane **1200**, optical connectors **1220** are placed adjacent to electrical connectors **1222**. The printed circuit boards **1230** are engaged with the electro-optical back plane **1200** using separate fibers **1224** on the board **1230** slotted into the electro optical back plane **1200** via both the electrical connectors **1222** and their corresponding optical connectors **1220**. Purely optical devices **1250** may also be plugged into the back plane **1200**. For example an optical switch **1252** is shown being connected to optical connectors **1220** alone, as is a splitter coupler device **1254**.

[0046] The present invention has been described in terms of preferred embodiments, however, it will be appreciated that various modifications and improvements may be made to the described embodiments without departing from the scope of the invention.

WHAT IS CLAIMED IS:

1. An optical connector for use with an electro-optical board, the optical connector comprising:

a right angle interface body having one or more first optical paths and one or more second optical paths, each of the first optical paths corresponding to a respective second optical path, wherein the first optical paths are disposed in a first plane and the one or more second optical paths are disposed in a second plane, the first and second planes being substantially at right angles with respect to one another;

a female self-alignment body having a tapered channel substantially aligned with the first plane; and

a tapered male self-alignment body sized to fit closely into the tapered channel of the female self-alignment body, and having one or more third optical paths adapted to align with the first optical paths when the tapered male self-alignment body is engaged with the female self-alignment body;

wherein the third optical paths are adapted for connection to one or more optical fibers disposed outside the electro-optical board, and

wherein the second optical paths are adapted for connection to optical fibers embedded in the electro-optical board.

2. The optical connector of claim 1, further comprising:

an anchor body adapted to securely engage an exterior surface of the female self-alignment body and adapted to anchor to a surface of the electro-optical board.

3. A method of integrating into an optical-electrical board an optical connector that includes a right angle interface body, a female self-alignment body having a tapered channel, and an anchor body, the method comprising:

connecting a right angle interface body to a set of one or more optical fibers;

embedding the right angle interface body and the one or more optical fibers inside the optical-electrical board;

forming a hole in the optical-electrical board to expose an upper surface of the embedded right angle interface body;

securely fastening the anchor body about the hole; and

inserting the female self-alignment body through the anchor body and the hole so as to bring the tapered channel into registration with the embedded right angle interface body.

4. The method of claim 3, wherein the one or more optical fibers comprise a fiber management system.

5. An electro-optical back plane comprising:

a fiber management system formed of plural optical fibers;

an electrical bus circuit;

a board, wherein the fiber management system and the electrical bus circuit are embedded inside the board;

plural optical connectors disposed on the board, each of the optical connectors being coupled to one or more of the plural optical fibers of the fiber management system; and

plural electrical connectors disposed on the board, each of the electrical connectors being electrically connected to the electrical bus circuit;

wherein each of the optical connectors comprises:

a right angle interface body embedded into the board for connection to one or more fibers of the fiber management system;

an anchor body securely fastened to the surface of the board; and

a female self-alignment body having a tapered channel, wherein the female self-alignment body is held by the anchor body so that the tapered channel is in registration with an upper surface of the right angle interface body.

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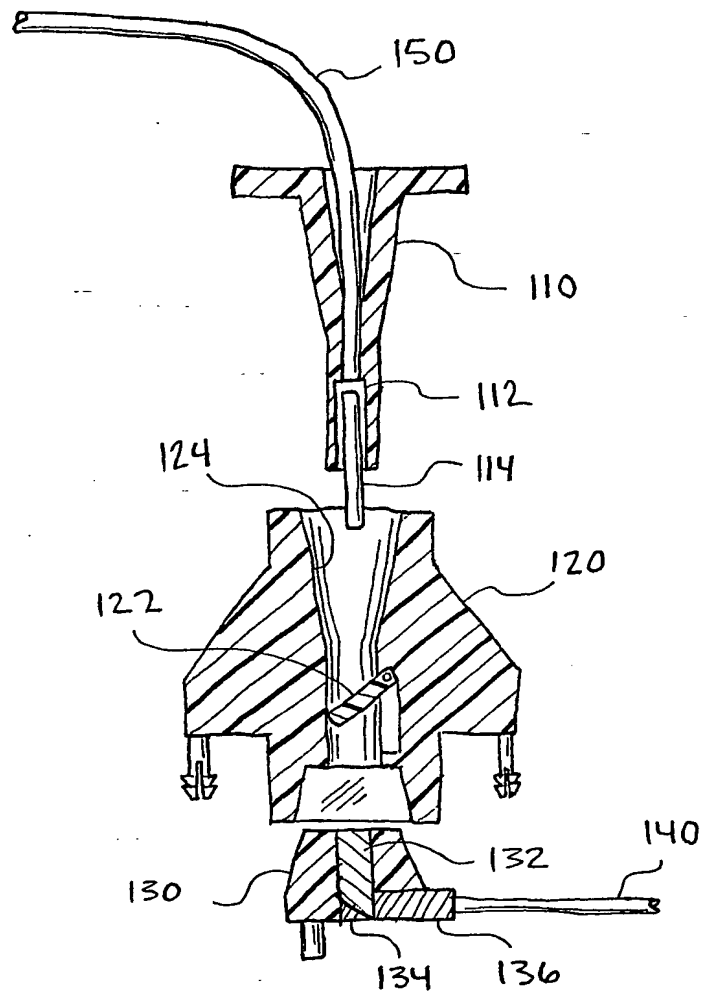


FIG. 1

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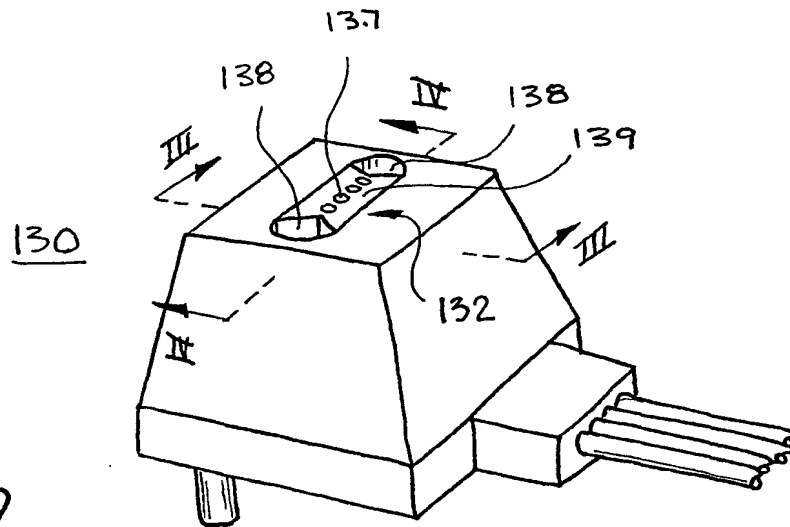


FIG. 2

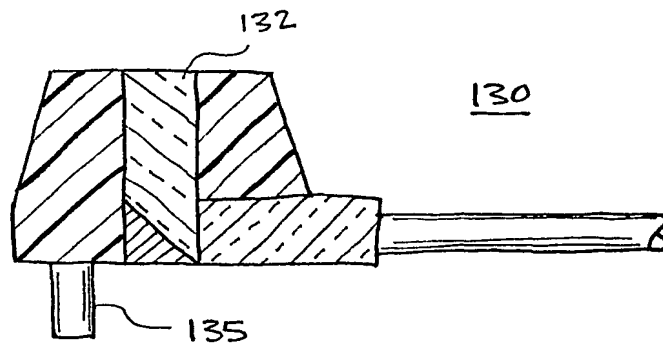


FIG. 3

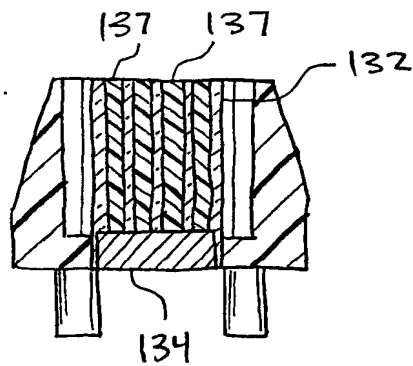


FIG. 4

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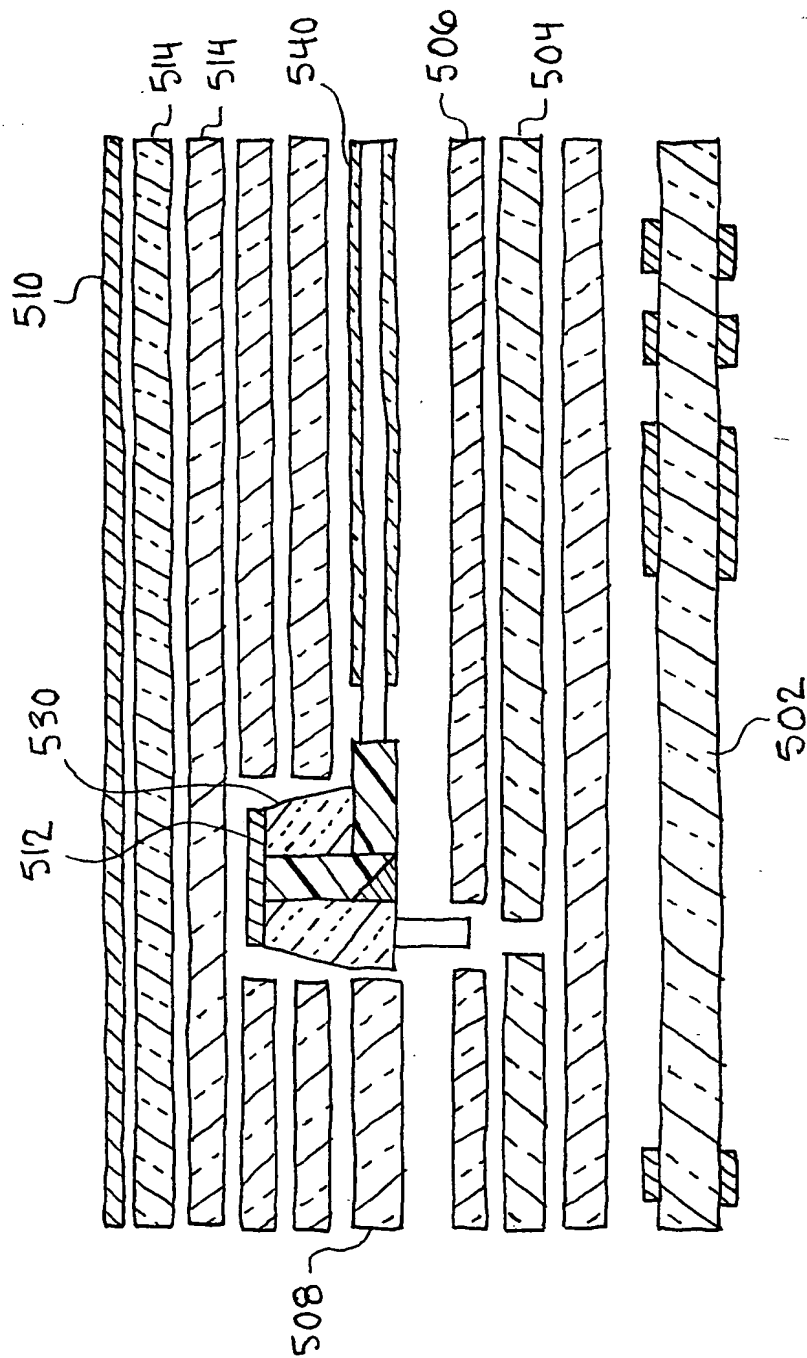


FIG. 5

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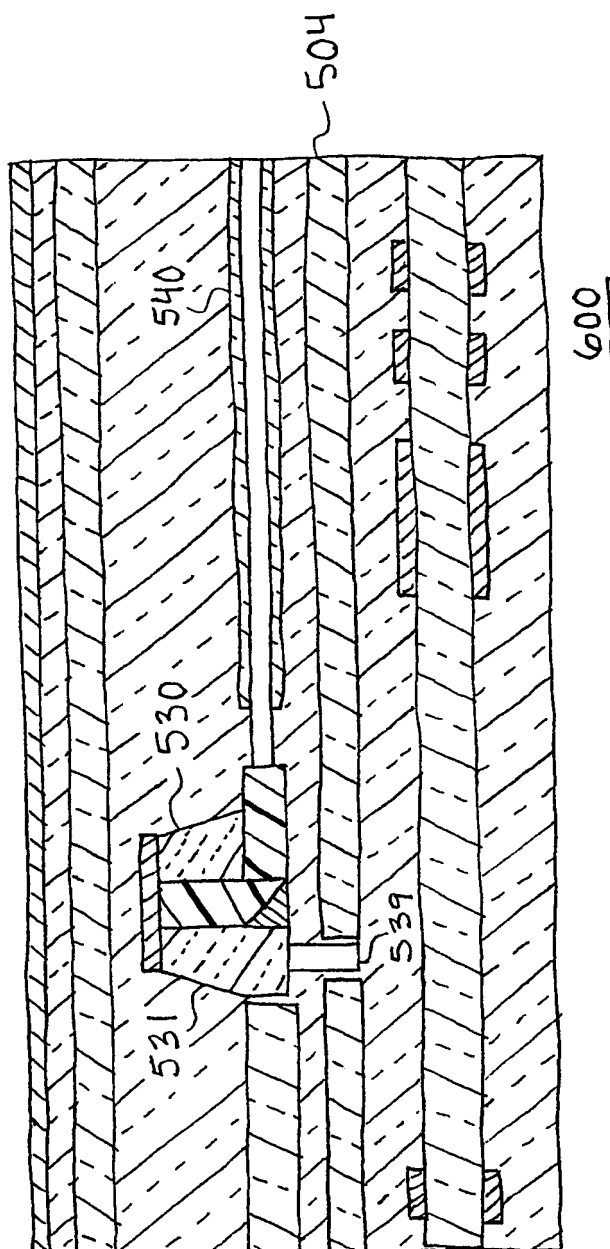


FIG. 6

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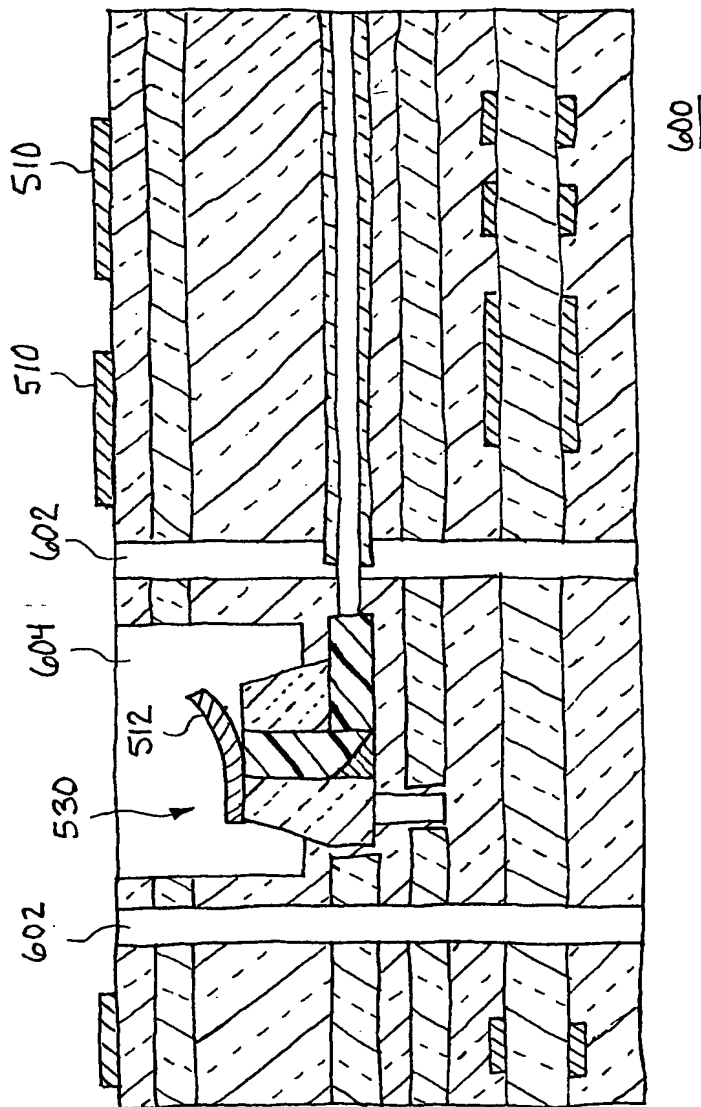
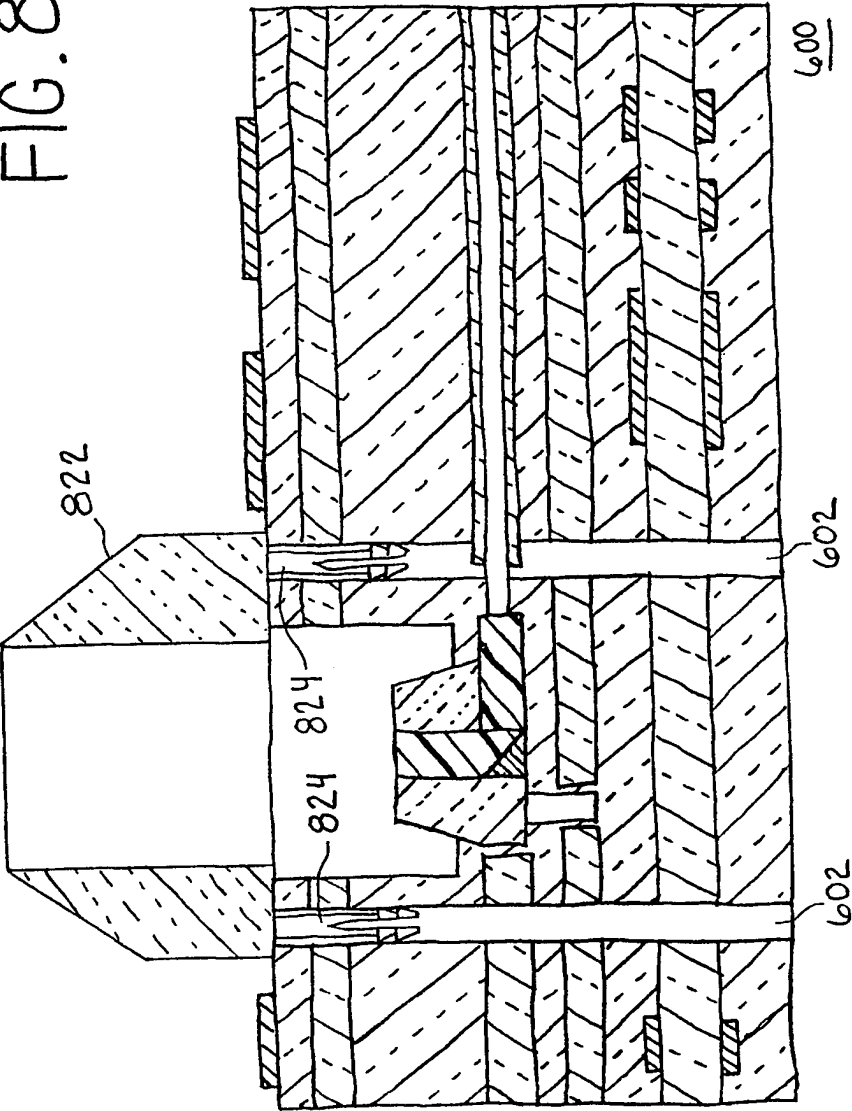
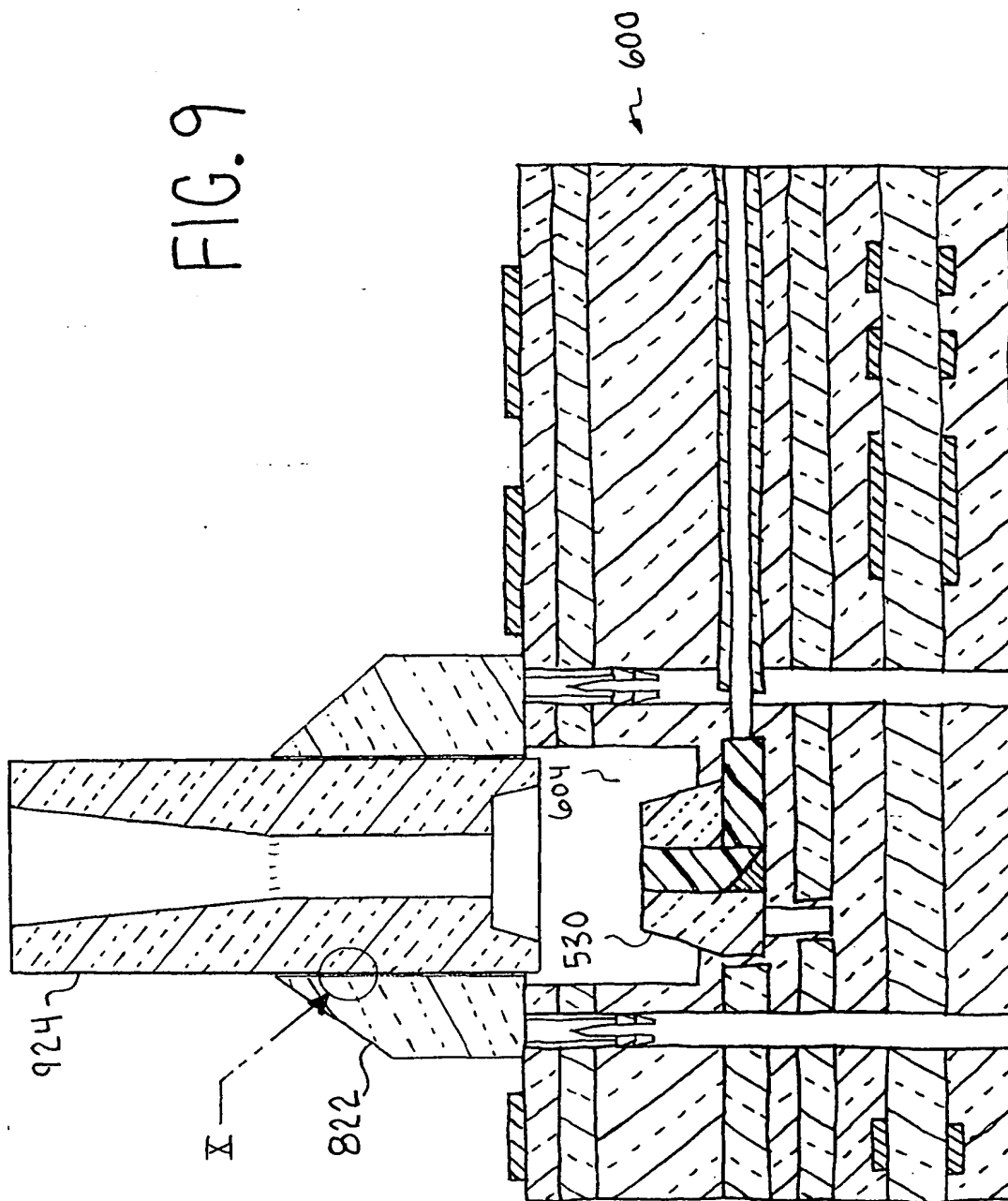


FIG. 7

FIG. 8





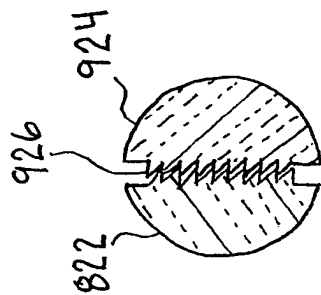


FIG. 10

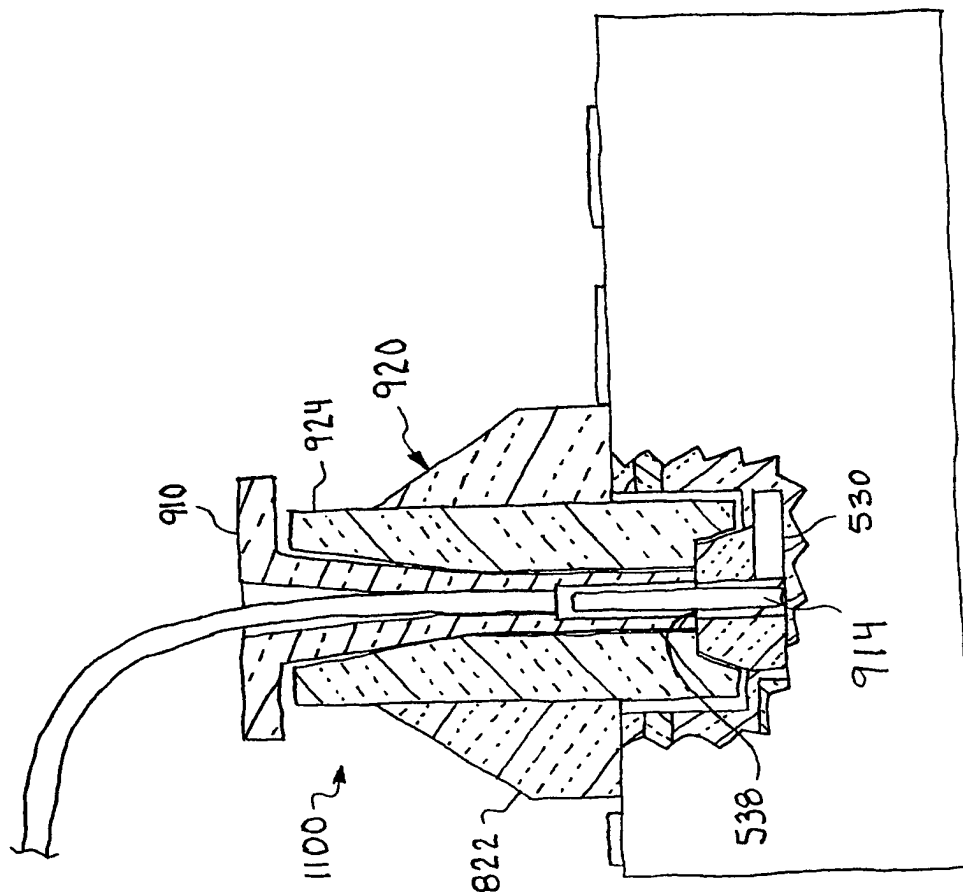


FIG. 11

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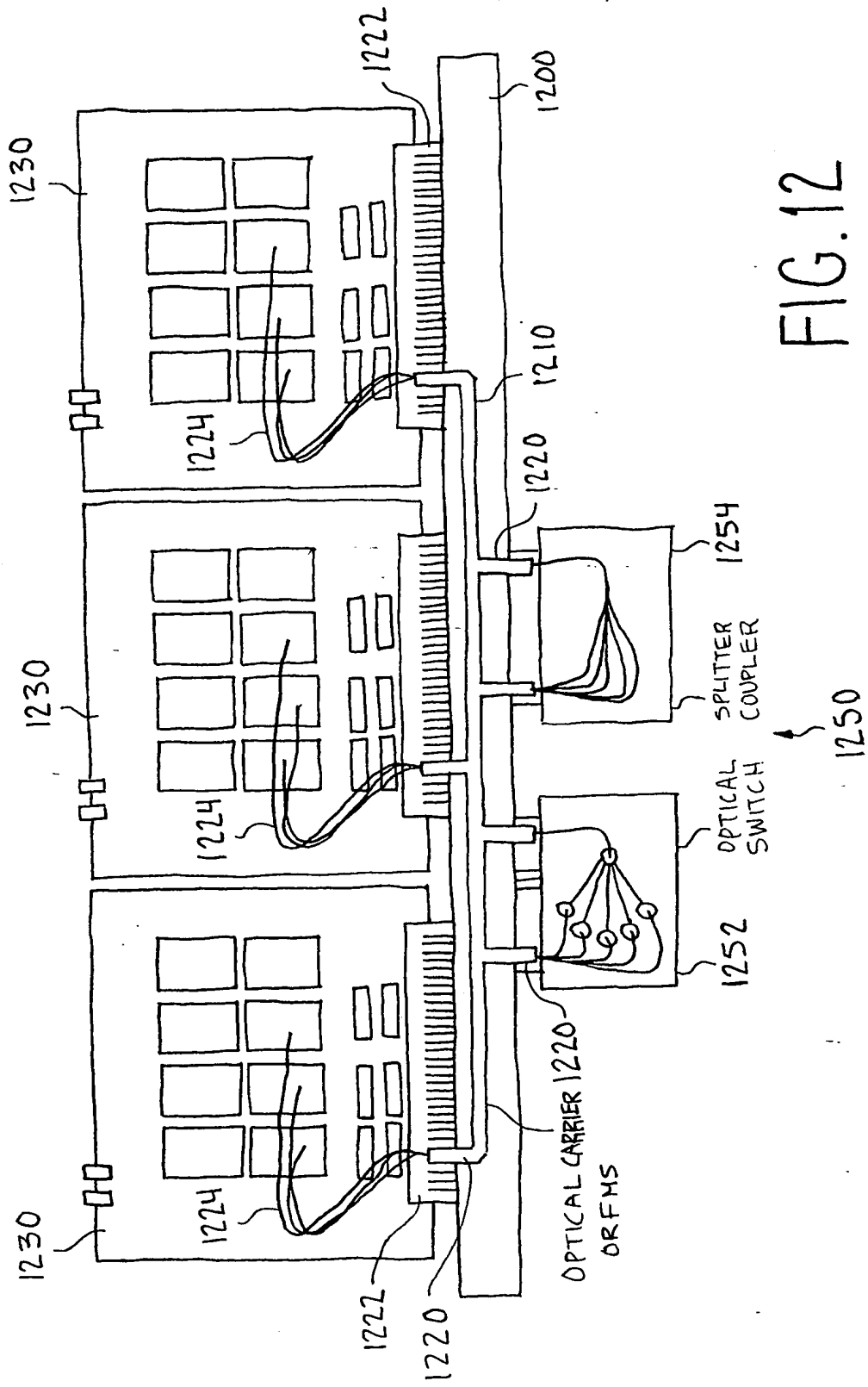


FIG. 12

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